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Electronic Patent Application Submission
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Application ID: 10766046



Title of Invention: LEADFRAME TYPE
SEMICONDUCTOR PACKAGE
HAVING REDUCED INDUCTANCE
AND ITS MANUFACTURING
METHOD

First Named Inventor: GI KIM

Domestic/Foreign Application: Domestic Application

Filing Date: 2004-01-28

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Statement

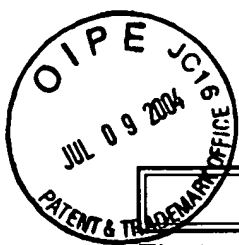
Filing Type:

Confirmation number: 2288

Attorney Docket Number: AMKOR099A


Total Fees Authorized:

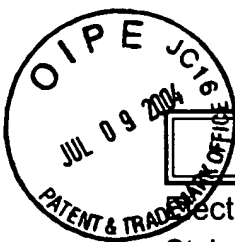
Digital Certificate Holder: cn=Mark B. Garred,ou=Registered Attorneys,ou=Patent and Trademark
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Electronic Version v1.1

Stylesheet Version v1.1.0

Title of Invention	LEADFRAME TYPE SEMICONDUCTOR PACKAGE HAVING REDUCED INDUCTANCE AND ITS MANUFACTURING METHOD									
<p>Application Number: 10/766046 </p> <p>Date: 2004-01-28</p> <p>First Named Applicant: GI JEONG KIM</p> <p>Confirmation Number: 2288</p> <p>Attorney Docket Number: AMKOR099A</p>										
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<table border="1"><thead><tr><th>Submitted by:</th><th>Elec. Sign.</th><th>Sign. Capacity</th></tr></thead><tbody><tr><td>MARK B. GARRED Registered Number: 34,823</td><td>/mbg/</td><td>Attorney</td></tr></tbody></table>			Submitted by:	Elec. Sign.	Sign. Capacity	MARK B. GARRED Registered Number: 34,823	/mbg/	Attorney		
Submitted by:	Elec. Sign.	Sign. Capacity								
MARK B. GARRED Registered Number: 34,823	/mbg/	Attorney								
<table><tr><td>Documents being submitted</td><td>Files</td></tr><tr><td>us-ids</td><td>ids4-usidst.xml</td></tr><tr><td></td><td>us-ids.dtd</td></tr><tr><td></td><td>us-ids.xsl</td></tr></table>			Documents being submitted	Files	us-ids	ids4-usidst.xml		us-ids.dtd		us-ids.xsl
Documents being submitted	Files									
us-ids	ids4-usidst.xml									
	us-ids.dtd									
	us-ids.xsl									
Comments										



ELECTRONIC INFORMATION DISCLOSURE STATEMENT

Electronic Version v18

Stylesheet Version v18.0

Title of
Invention

LEADFRAME TYPE SEMICONDUCTOR PACKAGE
HAVING REDUCED INDUCTANCE AND ITS
MANUFACTURING METHOD

Application Number: 10/766046
Confirmation Number: 2288
First Named Applicant: GI KIM
Attorney Docket Number: AMKOR099A
Art Unit: 2613

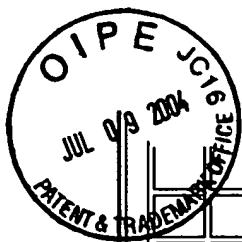


Search string: (5886398 or 5894108 or 5897339 or 5900676
or 5903049 or 5903050 or 5909053 or 5915998
or 5917242 or 5939779 or 5942794 or 5951305
or 5959356 or 5969426 or 5973388 or 5976912
or 5977613 or 5977615 or 5977630 or 5981314
or 5986333 or 5986885 or 6001671 or 6013947
or 6018189 or 6020625 or 6025640 or 6031279
or 6034423 or RE36613 or 6040626 or 6043430
or 6060768 or 6060769 or 6072228 or 6075284
or 6081029 or 6084310 or 6087715 or 6087722
or 6100594 or 6114752 or 6113474 or 6118174
or 6118184 or 6130115 or 6130473 or RE36907
or 6133623 or 6140154).pn.

US Patent Documents

Note: Applicant is not required to submit a paper copy of cited US Patent Documents

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Signature

Examiner Name	Date